



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Sheng-Hsuing Chen §
Serial No.: 09/755,282 §
Filed: January 1, 2001 §
For: Method of Improving Copper §
Pad Adhesion §

Docket No.: 1999-0149 (24061.302)
Examiner: Mitchell, James M.
Group Art Unit: 2827
Conf. No.: 6859

TRANSMITTAL

Mail Stop: AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Enclosed for filing in the above-identified patent application.

1. Amendment in Response to the Office Action dated October 4, 2004;
2. This transmittal (in duplicate); and
3. Return postcard.

The Director is authorized to charge any deficiency fees or credit any overpayments to Deposit Account No. 08-1394 of Haynes and Boone, LLP.

Respectfully submitted,

Timothy F. Bliss

Timothy F. Bliss
Reg. No. 50,925

Date: 12/17/04

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File: 24061.302

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop: Amendment, Commissioner For Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date indicated below:

Bonnie Boyle
Bonnie Boyle

Date 12-17-04



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Sheng-Hsiung Chen

Serial No.: 09/755,282

Filed: January 1, 2001

For: METHOD OF IMPROVING COPPER
PAD ADHESION

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Attorney Docket No. 24061.302
(1999-0149)

Customer No. 42717

Group Art Unit: 2827

Examiner: Mitchell, James M.

RESPONSE

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the non-final Office Action mailed October 4, 2004, please reconsider the application in light of the following amendments and remarks:

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 5 of this paper.